

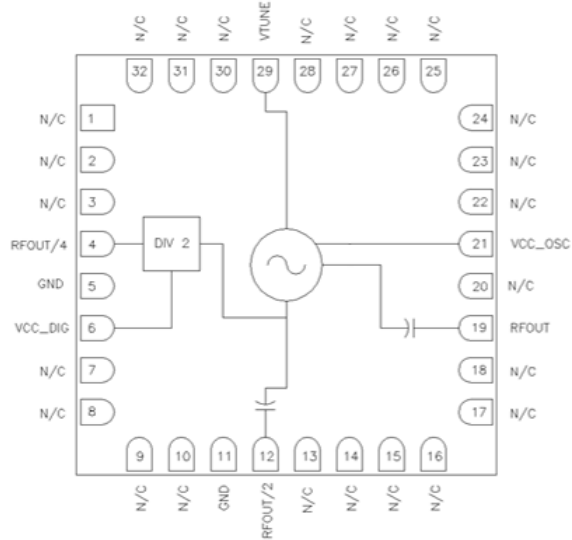


Features

- Multiple Frequency Outputs
 - Fo: 9.3GHz to 10.7GHz
 - Fo/2: 4.65GHz to 5.35GHz
 - Fo/4: 2.33GHz to 2.68GHz
- No External Resonator Required
- Integrated Frequency Divider
- Phase Noise: -115dBc/Hz at 100kHz Offset
- Flat Output Power Over Frequency Tuning Range 1.5V to 14.5V
 - Fo: 8dBm
 - Fo/2: 7dBm
 - Fo/4: -2dBm
- Low Power Consumption
 - 5V/275mA (Divider On)
 - 5V/215mA (Divider Off)
- 32-Lead 5mm x 5mm Plastic Overmolded QFN

Applications

- Point-to-Point Radio
- Point-to-Multipoint Radio
- Satellite Communications
- Test Equipment
- Military
- Aerospace



Functional Block Diagram

Product Description

RFMD's RFVC1842 is a 5V InGaP MMIC VCO with an integrated frequency divider providing additional Fo/2 and Fo/4 outputs. With an Fo frequency range of 9.3GHz to 10.7GHz its monolithic structure provides excellent temperature, shock, and vibration performance. Output power (Fo) is +8dBm and is flat across the tuning voltage range of 1.5V to 14.5V. Phase noise is typically -115dBc/Hz at 100kHz offset. The device operates from a low supply current of 275mA which can be further reduced to 215mA by disabling the divider functions if not required. The RFVC1842 is available in a low cost 5mm x 5mm surface mount plastic overmolded QFN outline.

Ordering Information

RFVC1842S2	Sample bag with 2 pieces
RFVC1842SB	Sample bag with 5 pieces
RFVC1842SQ	Bag with 25 pieces
RFVC1842SR	Bag with 100 pieces
RFVC1842TR7	7" Reel with 750 pieces
RFVC1842PCBA-410	Evaluation Board

Optimum Technology Matching® Applied

- | | | | |
|---|--------------------------------------|-------------------------------------|------------------------------------|
| <input type="checkbox"/> GaAs HBT | <input type="checkbox"/> SiGe BiCMOS | <input type="checkbox"/> GaAs pHEMT | <input type="checkbox"/> GaN HEMT |
| <input type="checkbox"/> GaAs MESFET | <input type="checkbox"/> Si BiCMOS | <input type="checkbox"/> Si CMOS | <input type="checkbox"/> BiFET HBT |
| <input checked="" type="checkbox"/> InGaP HBT | <input type="checkbox"/> SiGe HBT | <input type="checkbox"/> Si BJT | <input type="checkbox"/> LD MOS |

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Absolute Maximum Ratings

Parameter	Rating	Unit
V_{CC_OSC}, V_{CC_DIG}	+5.5	V
V_{TUNE}	0 to +15	V
Junction Temperature (T_J)	135	°C
Continuous P_{DISS} ($T_A = 85\text{ °C}$) (derate 37mW/°C above $T_A = 85\text{ °C}$)	1.65	W
Junction to Case, Thermal Resistance ($R_{\theta(j-a)}$)	30	°C/W
Storage Temperature	-65 to +150	°C
Operating Temperature	-40 to +85	°C
ESD Sensitivity (HBM)	Class 1A	



Caution! ESD sensitive device.

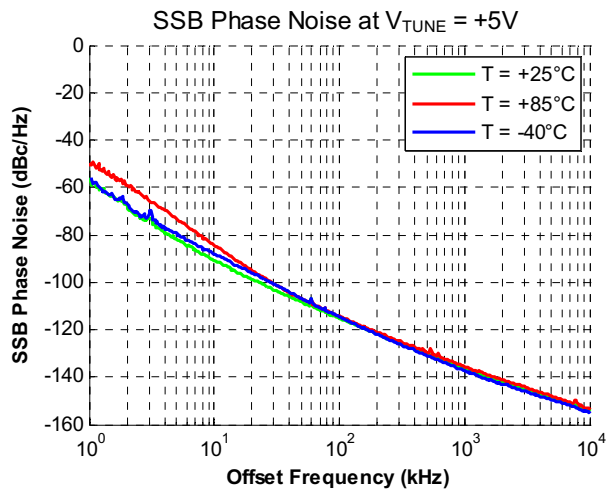
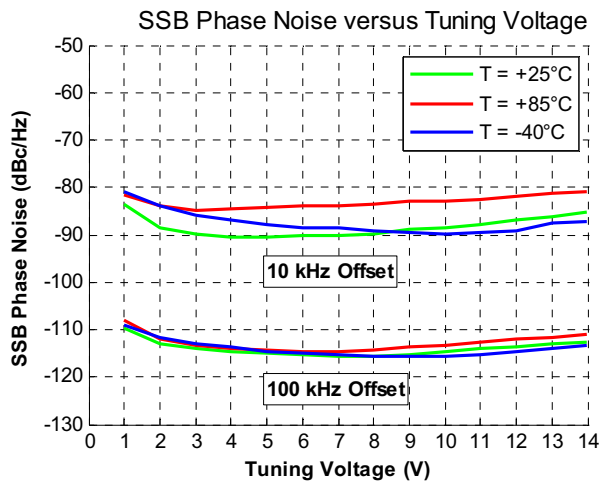
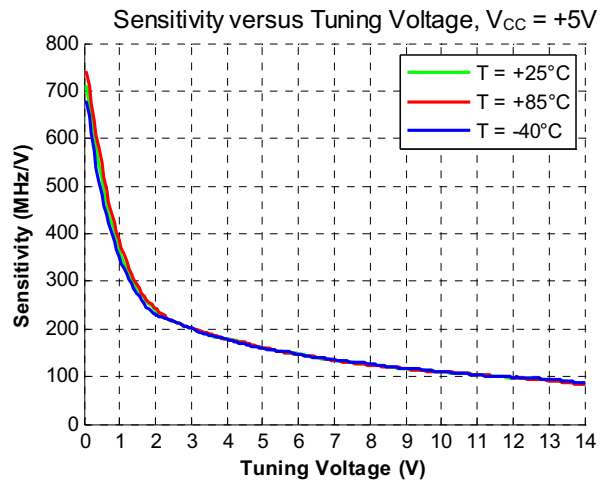
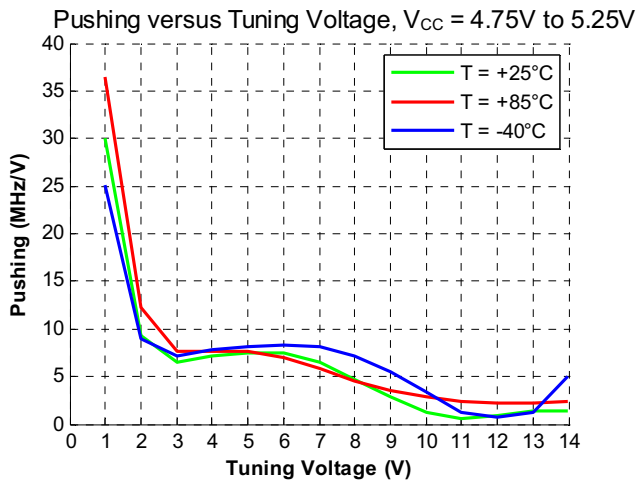
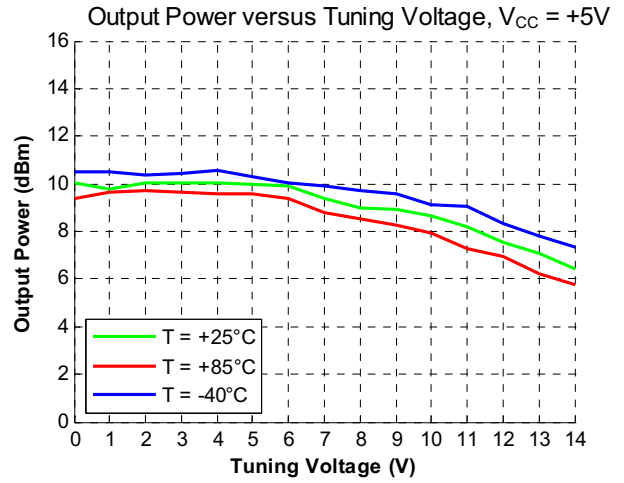
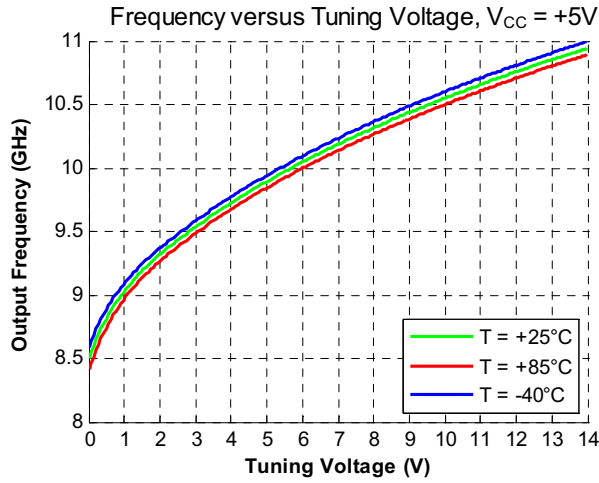
Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

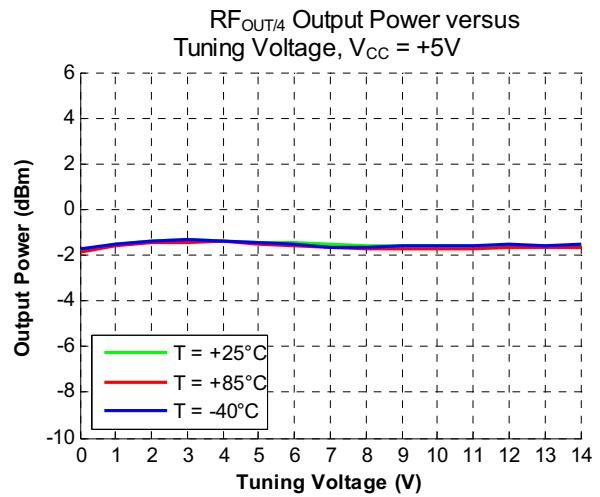
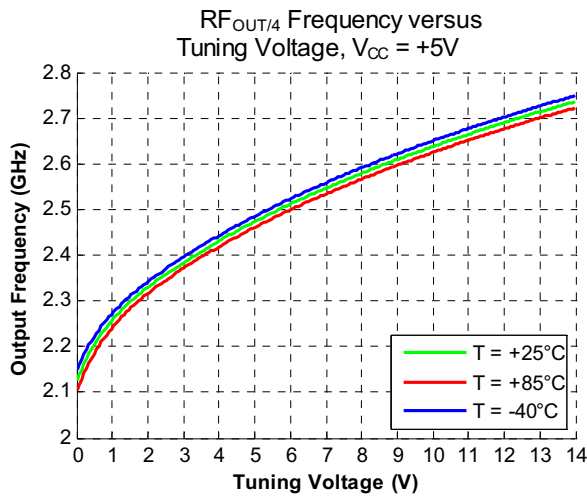
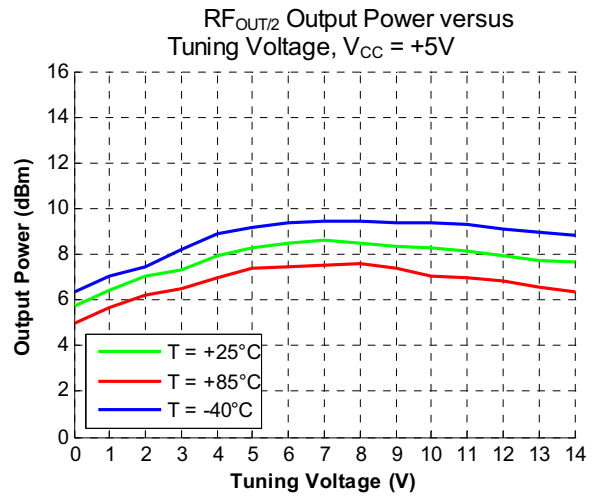
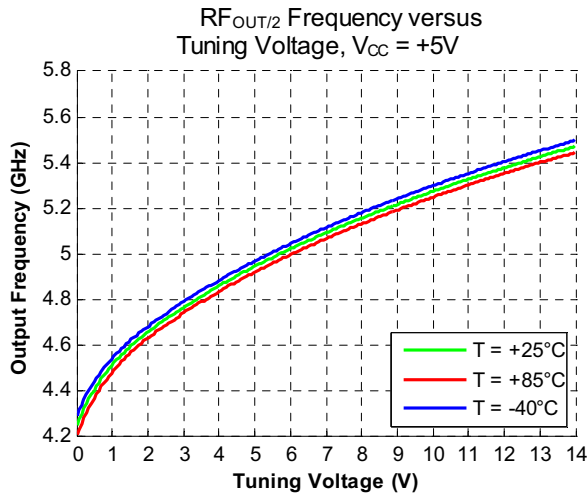
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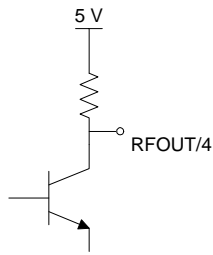
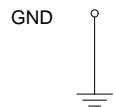
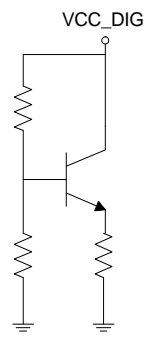
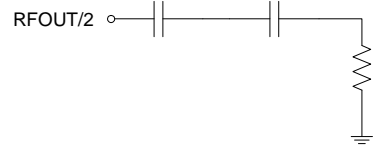
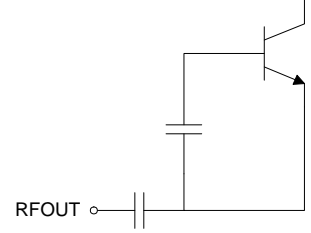
RFMD Green: RoHS compliant per EU Directive 2002/95/EC, halogen free per IEC 61249-2-21, < 1000ppm each of antimony trioxide in polymeric materials and red phosphorus as a flame retardant, and <2% antimony in solder.

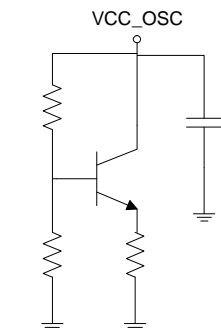
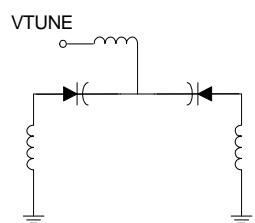
Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
Electrical Specifications					$V_{CC} = 5V, T_A = +25\text{ °C}$
Operating Frequency					
F_o	9.3		10.7	GHz	
$F_o/2$	4.65		5.35	GHz	
$F_o/4$	2.325		2.675	GHz	
Output Power					
F_o		8		dBm	
$F_o/2$		7		dBm	
$F_o/4$		-2		dBm	
SSB Phase Noise					
10kHz offset at RF_{OUT}		-90		dBc/Hz	$V_{TUNE} = 5V$
100kHz offset at RF_{OUT}		-115		dBc/Hz	$V_{TUNE} = 5V$
Tune Voltage	1.5		14.5	V	
Supply Voltage (Oscillator and Divider)		5		V	
Supply Current					
V_{CC_OSC}		215		mA	
V_{CC_DIG}		60		mA	
Tune Port Leakage Current		10		μA	
Output Return Loss		5		dB	
Harmonics/Sub-harmonics					Measured with RF probes at package, not at SMA connections on EVB
1/2		50		dBc	
3/2		40		dBc	
2 nd		10		dBc	
3 rd		20		dBc	
Pulling (into a 2.0:1 VSWR)		5		MHz pp	
Pushing		10		MHz/V	
Frequency Drift Rate		0.8		MHz/°C	



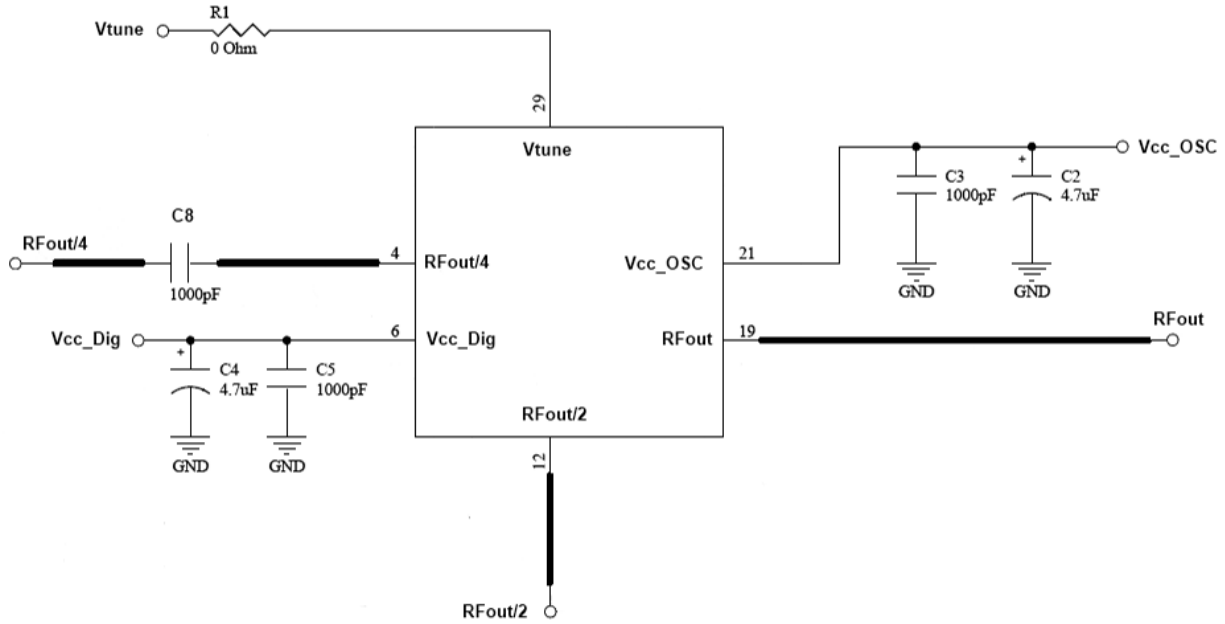


Pin Names and Description

Pin	Function	Description	Interface Schematic
1-3,7-10, 13-18, 20, 22-28,30-32	N/C	No internal connection.	
4	RFOUT/4	VCO RF output at $F_o/4$. Externally DC-blocked.	
5,11,Package Base	GND	Connect to PCB ground.	
6	VCC_DIG	Supply voltage input for the integrated frequency divider. Typical +5V. Ground this pin to disable digital divider and reduce current consumption by 60mA.	
12	RFOUT/2	VCO RF output at $F_o/2$. Internally DC-blocked.	
19	RFOUT	VCO RF output at F_o . Internally DC-blocked.	

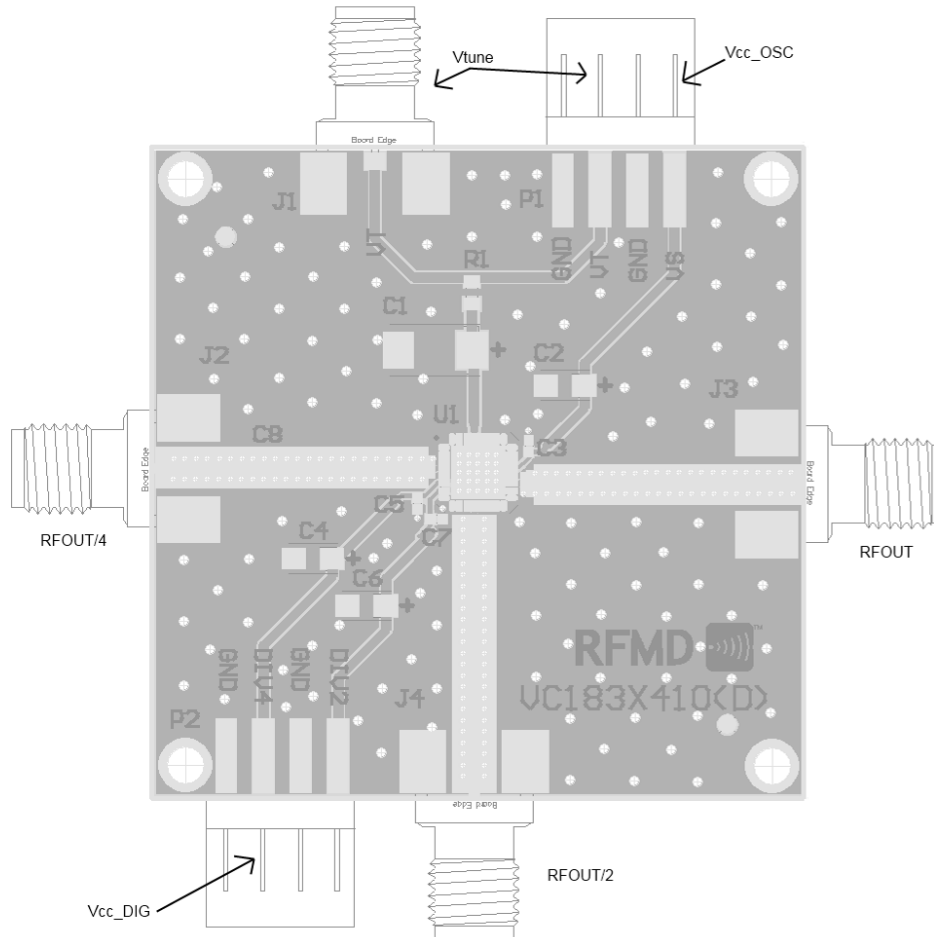
21	VCC_OSC	Supply voltage input for the VCO. Typical +5V.	
29	VTUNE	VCO control voltage input.	

Sample Application Circuit Schematic



Bias Conditions	Output
$V_{CC_OSC} = 5V$	$F_{OUT} = 10GHz$
$V_{CC_DIG} = 5V$	$F_{OUT/2} = 5GHz$
$V_{TUNE} = 5V$	$F_{OUT/4} = 2.5GHz$

Evaluation Board Layout



List of Materials for Evaluation Board

Item	Description
U1	RFVC1842 VCO
C3, C5, C7, C8	1000pF Capacitor, 0402 Package
C2, C4, C6	4.7µF Tantalum Capacitor
C1	68 µF Tantalum Capacitor
R1	0 Ω Resistor, 0603 Package
P1, P2	4-PIN DC connector
J1, J2, J3, J4	PCB mount SMA connector
PCB	VC183x410(D)